

RF Amplifier for CD Players

Description

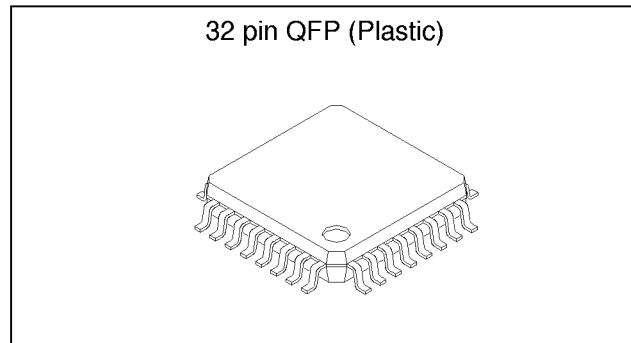
The CXA2521Q is an IC for RF signal processing of compact discs.

Features

- Supports quadruple speed (RF signal fc 8MHz)
- Peak hold circuit time constant of mirror circuit can be adjusted (switching function provided)
Accurate mirror detection is possible from traverse signal of high/low speed search
- Fluctuations of characteristics are very small, which are caused by variations of resistance value and deviations of temperature characteristics for IC internal/external resistors, because the input and feedback resistors of the tracking error amplifier are externally attached
- APC (Automatic Power Control) function

Functions

- RF summing amplifier
- Focus error amplifier
- Tracking error amplifier
- APC circuit
- Focus OK detection function
- Defect detection function
- Mirror detection function



Absolute Maximum Ratings

• Supply voltage	V _{CC}	7	V
• Storage temperature	T _{STG}	-65 to +150	°C
• Allowable power dissipation	P _D	800	mW

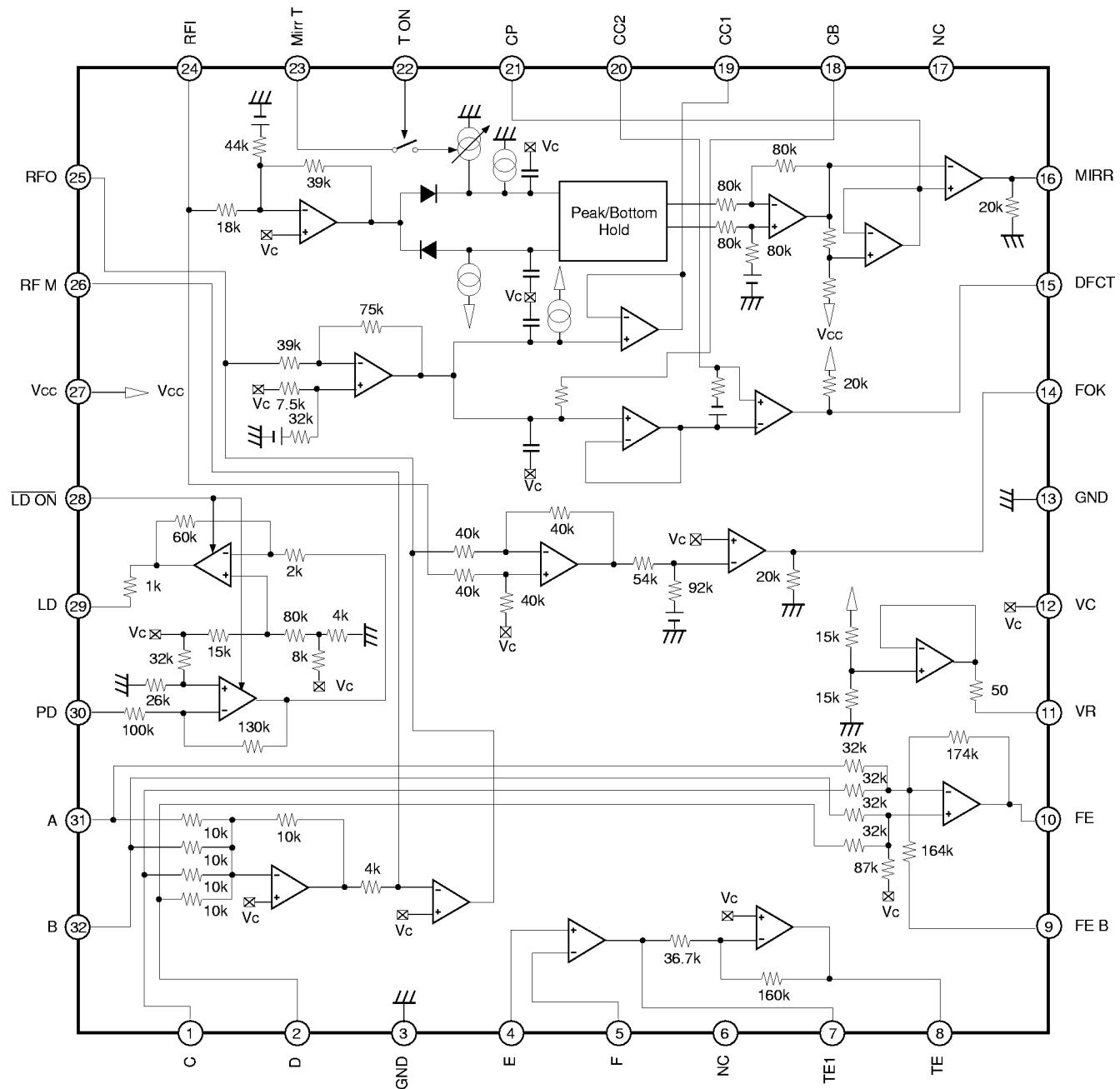
Operating Conditions

• Supply voltage	V _{CC} -GND	+4.5 to +5.5	V
• Operating temperature	T _{OPR}	-20 to +75	°C

Applications

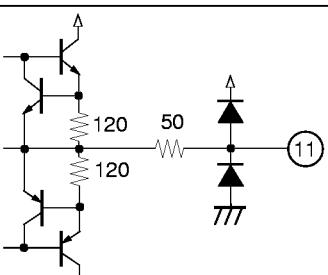
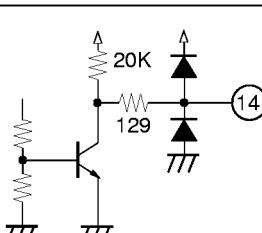
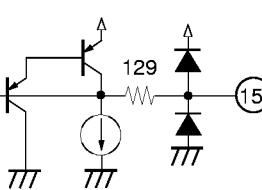
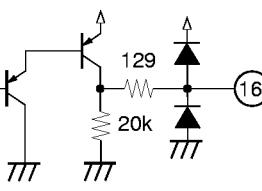
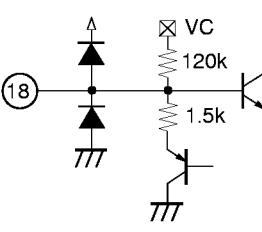
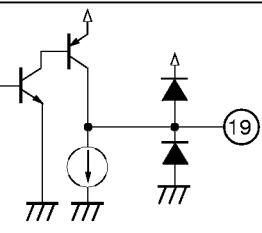
- Compact disc players
- CD-ROM drive

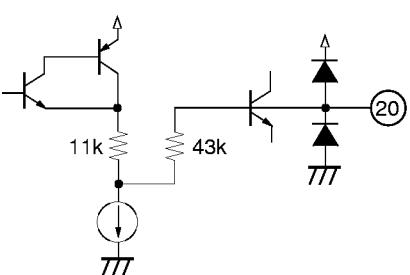
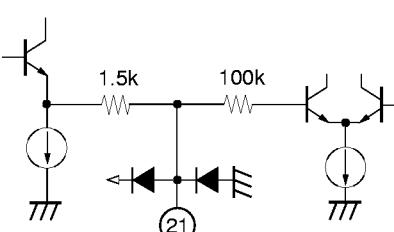
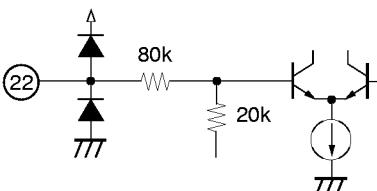
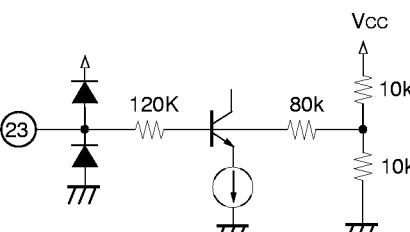
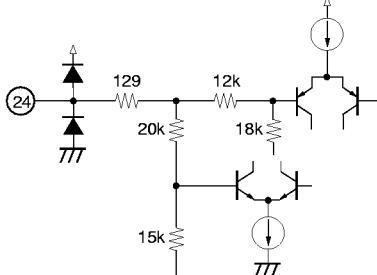
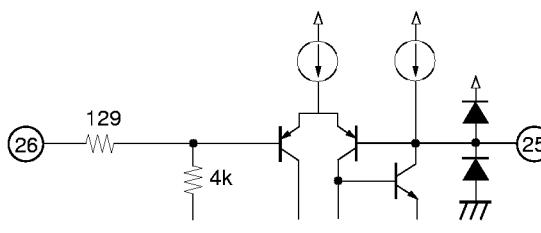
Block Diagram

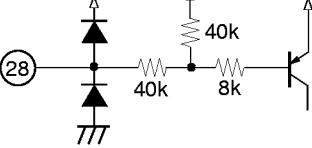
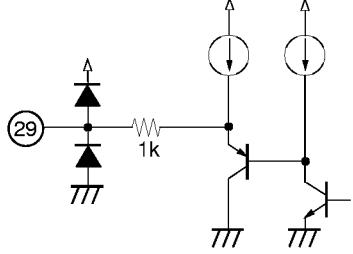
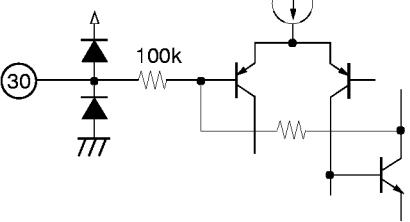


Pin Description

Pin No.	Symbol	I/O	Equivalent Circuit	Description
31 32 1 2	A B C D	-		Input of RF summing amplifier and focus error amplifier.
3	GND			Ground.
4 5 7 8	E F TE1 TE	- -O-O		Tracking error amplifier input for Pins 4 and 5; tracking error amplifier output and tracking error drive input for Pin 7; tracking error drive output for Pin 8.
6	NC			Not connected.
9 10	FE B FE	- -O		Focus bias adjustment of focus amplifier for Pin 9; focus error amplifier output for Pin 10.

Pin No.	Symbol	I/O	Equivalent Circuit	Description
11	VR	O		(Vcc+GND)/2 DC voltage output.
12	VC	I		VC center voltage input.
13	GND			Ground.
14	FOK	O		FOK comparator output.
15	DFCT	O		Defect comparator output.
16	Mirr	O		Mirror comparator output.
17	NC			Not connected.
18	CB	I		Capacitor connection of Defect bottom hold.
19	CC1	O		Defect bottom hold output.

Pin No.	Symbol	I/O	Equivalent Circuit	Description
20	CC2	I		Input of Defect bottom hold output with capacitance coupled.
21	CP	I		Capacitor connection of mirror hold. Non-inversion input of mirror comparator.
22	T ON	I		Peak hold time constant switching. Time constant can be adjusted by connecting this pin to Vcc; fixed by connecting to GND.
23	Mirr T	I		Peak hold time constant adjustment. This is the time constant which is adjusted when Pin 22 is ON.
24	RFI	I		Input of RF summing amplifier output with capacitance coupled.
25 26	RFO RF M	O I		Non-inversion input of RF drive amplifier for Pin 26; RF signal output for Pin 25; resistance value connected between Pins 25 and 26 which determines the low frequency gain of RF drive amplifier.

Pin No.	Symbol	I/O	Equivalent Circuit	Description
27	Vcc			Vcc
28	LD ON	I	(28) 	APC amplifier ON/OFF switching. OFF when connecting to Vcc; ON when connecting to GND.
29	LD	O	(29) 	APC amplifier output.
30	PD	I	(30) 	APC amplifier input.

Electrical Characteristics

Measure ment No.	Measurement Item	Symbol	SW Conditions						Bias Conditions						Measure ment Point	Description of Output Waveform and Measurement Method		Min.	Typ.	Max.	Unit
1	Current consumption	I _{CC}			0		0V	-2.0V	0V	-2.0V	300mV	27		Pin DC current measurement	8	12	15	mA			
2	Current consumption	I _{EE}			0		0V	-2.0V	0V	-2.0V	300mV	3 + 13		Pin DC current measurement	-15	-12	-8	mA			
3	Offset voltage	V ₁₋₁									2.0V	0V	25	DC voltage measurement	-40	0	40	mV			
4	Voltage gain	G ₁₋₁	0	0										V ₁ = 100mVpp f = 1kHz	15.5	18.5	21.5	dB			
5	Frequency response	F ₁₋₁	0	0										V ₁ = 100mVpp f = 8MHz Difference for G ₁₋₁	-3	—	—	dB			
6	Maximum output amplitude H	V ₁₋₂	0	0							300mV			DC voltage measurement	1.3	—	—	V			
7	Maximum output amplitude L	V ₁₋₃	0	0							-300mV			DC voltage measurement	—	—	-0.3	V			
8	Offset voltage	V ₂₋₁							0V			10		DC voltage measurement	-30	0	30	mV			
9	Voltage gain 1	G ₂₋₁	0											V ₁ = 100mVpp f = 1kHz	17.7	20.7	23.7	dB			
10	Voltage gain 2	G ₂₋₂	0											V ₁ = 100mVpp f = 1kHz	17.7	20.7	23.7	dB			
11	Voltage gain difference	G ₂₋₃												G ₂₋₁ - G ₂₋₂	-3	0	3	dB			
12	Frequency response 1	F ₂₋₁	0											V ₁ = 100mVpp f = 90kHz Difference for G ₂₋₁	-3	—	—	dB			
13	Frequency response 2	F ₂₋₂	0								300mV			V ₁ = 100mVpp f = 90kHz Difference for G ₂₋₂	-3	—	—	dB			
14	Maximum output amplitude H	V ₂₋₂	0											DC voltage measurement	1.9	—	—	V			
15	Maximum output amplitude L	V ₂₋₃	0						300mV					DC voltage measurement	—	—	-1.9	V			
16	Offset voltage	V ₃₋₁						0V	-2.0V	0V	2.0V	0V	8	DC voltage measurement	-30	0	30	mV			
17	Voltage gain 1	G ₃₋₁	0											V ₁ = 100mVpp f = 1kHz	17.9	20.9	23.9	dB			
18	Voltage gain 2	G ₃₋₂	0											V ₁ = 100mVpp f = 1kHz	17.9	20.9	23.9	dB			
19	Voltage gain difference	G ₃₋₃												G ₃₋₁ - G ₃₋₂	-3	0	3	dB			
20	Frequency response 1	F ₃₋₁	0											V ₁ = 100mVpp f = 90kHz Difference for G ₃₋₁	-3	—	—	dB			
21	Frequency response 2	F ₃₋₂	0											V ₁ = 100mVpp f = 90kHz Difference for G ₃₋₂	-3	—	—	dB			

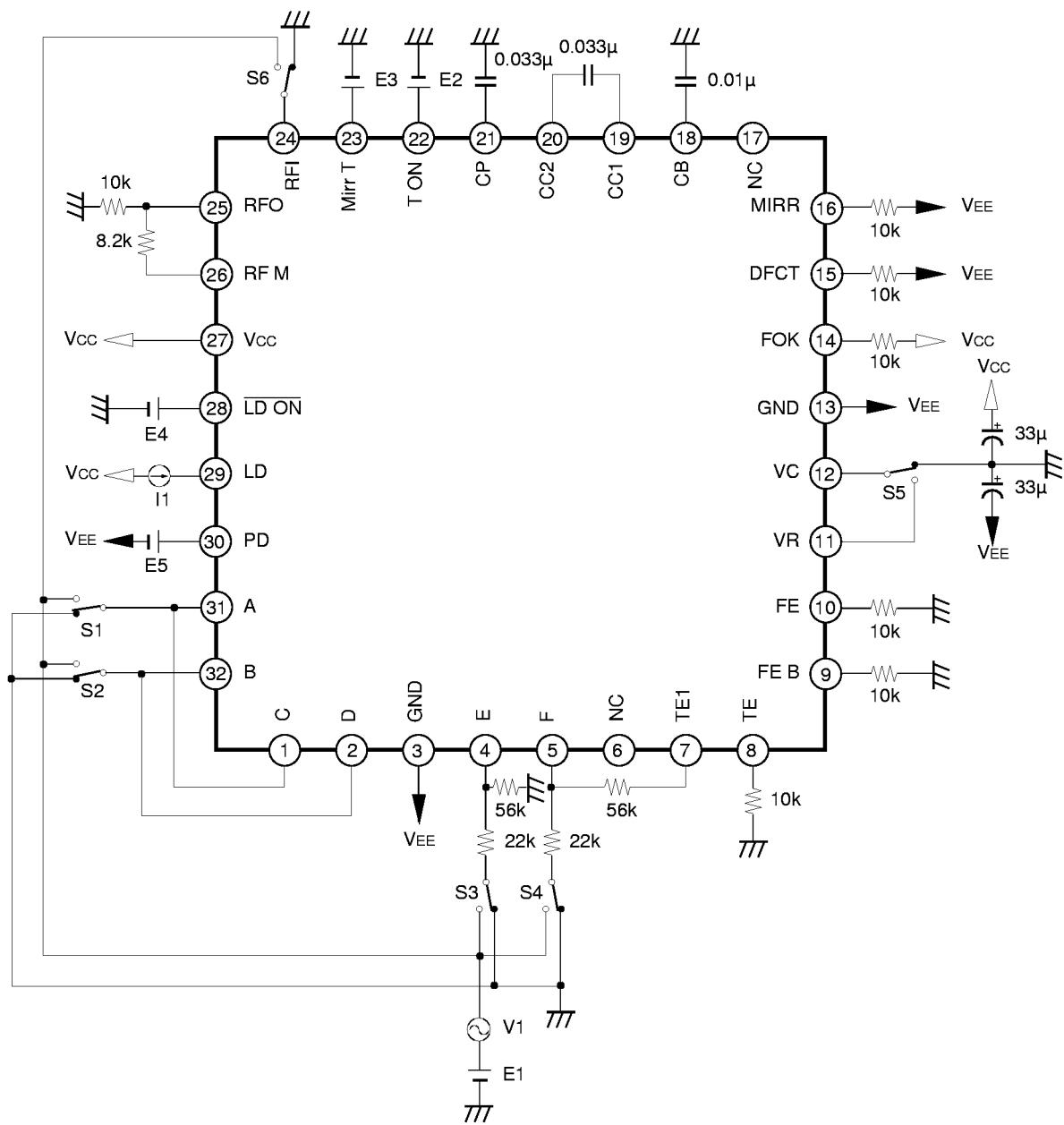
(Ta = +25°C, Vcc = +2.5V, GND = Vc, VEE = -2.5V)

Measure ment No.	Measurement Item	Symbol	SW Condition					Bias Conditions			Measure ment Point	Description of Output Waveform and Measurement Method		Min.	Typ.	Max.	Unit		
22	Maximum output amplitude H	V3-2	S1	S2	S3	S4	S5	S6	E1	E2	E3	E4	E5	Dc voltage measurement	1.9	—	—	V	
23	Maximum output amplitude L	V3-3	0	0	0	0	0	0	300mV	-2.0V	0V	2.0V	0V	Dc voltage measurement	—	—	—	-1.9 V	
24	Threshold voltage	V4-1							0	change				Pin 15 voltage where Pin 22 becomes 0V (GND)	-400	—	-300	mV	
25	High level output voltage	V4-2							0	-375mV				14 V1 = 1.0Vpp f = 5kHz	2.2	—	—	V	
26	Low level output voltage	V4-3							0	0				14 V1 = 1.0Vpp f = 5kHz	—	—	-1.8	V	
27	Maximum operating frequency	F4-1							0	→				V1 = 1.0Vpp	45	—	—	kHz	
28	High level output voltage	V5-1	0	0	0	0	0	0	43mV					15 V1 = 90mVpp f = 1kHz	1.8	—	—	V	
29	Low level output voltage	V5-2	0	0	0	0	0	0						15 V1 = 90mVpp f = 1kHz	—	—	-2	V	
30	Minimum operating frequency	F5-1	0	0	0	0	0	0						15 V1 = 90mVpp	—	—	1	kHz	
31	Maximum operating frequency	F5-2	0	0	0	0	0	0						15 V1 = 90mVpp	2	—	—	kHz	
32	Minimum operating input voltage	V5-3	0	0	0	0	0	0						f (V1) = 50Hz at RFO output voltage	—	—	0.5	Vpp	
33	Maximum operating input voltage	V5-4	0	0	0	0	0	0						f (V1) = 50Hz at RFO output voltage	1.8	—	—	Vpp	
34	High level output voltage	V6-1							0	-0.4V	-2.0V	0V	2.0V	0V	16 V1 = 0.8Vpp f = 10kHz	1.8	—	—	V
35	Low level output voltage	V6-2							0	-0.4V	0	0	0	V1 = 0.8Vpp f = 10kHz	—	—	-2	V	
36	Bottom hold frequency response	F6-1							0	-0.2V				V1 = 0.8Vpp 55% AM modulation carrier = 500Hz	—	400	600	Hz	
37	Bottom hold frequency response	F6-2							0	-0.4V				V1 = 0.8Vpp	—	550	900	Hz	
38	Maximum operating frequency 1	F6-3	0	0	0	0	0	0						V1 = 0.8Vpp	30	—	—	kHz	
39	Maximum operating frequency 2	F6-4							0	0	0	0		V1 = 0.8Vpp	80	—	—	kHz	
40	Minimum operating input voltage	V6-3							0	-2.0V	0V			f (V1) = 10kHz	—	0.1	0.2	Vpp	
41	Maximum operating input voltage	V6-4							0	0	0	0		f (V1) = 10kHz	1.8	—	—	Vpp	

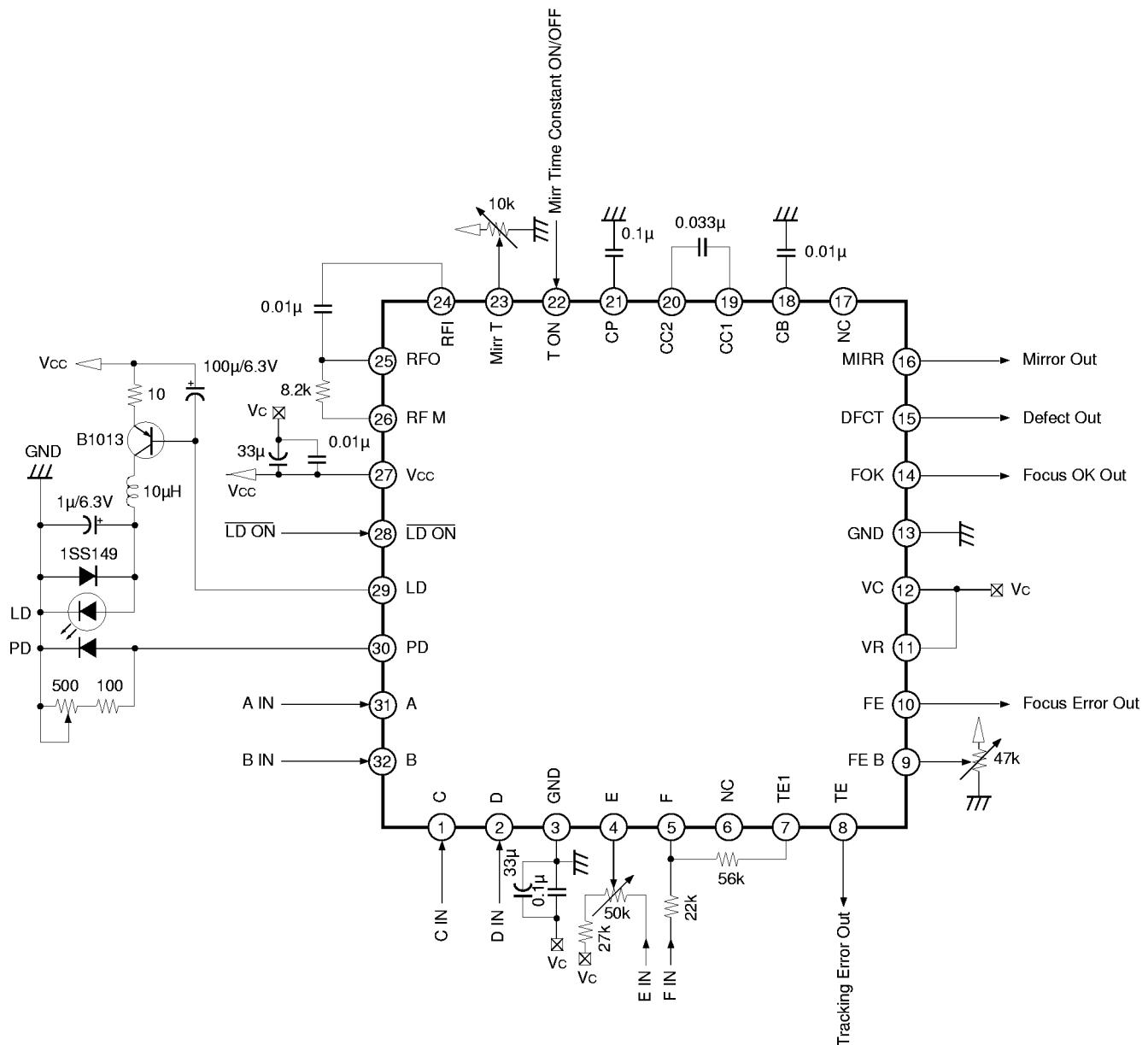
(Ta = +25°C, Vcc = +2.5V, GND = Vc, VEE = -2.5V)

Measure ment No.	Measurement Item	Symbol	SW Conditions						Bias Conditions				Measure ment Point	Description of Output Waveform and Measurement Method	Max.	Typ.	Max.	Unit	
			S1	S2	S3	S4	S5	S6	E1	E2	E3	E4	E5						
42	Output voltage 1	V7-1							0V	-2.0V	0V	-2.0V	69mV	29	DC voltage measurement	-	-1.6	-0.3	V
43	Output voltage 2	V7-2											123mV		DC voltage measurement	-1.2	0.1	1.4	V
44	Output voltage 3	V7-3											177mV		DC voltage measurement	0.8	2.1	-	V
45	Output voltage 4	V7-4											2.0V	0V	DC voltage measurement	2.1	2.4	-	V
46	Output voltage 5	V7-5											-2.0V		I1 = 0.8mA DC voltage measurement	-	-	0	V
47	Output voltage	V8-1							○				2.0V	↓	11 DC voltage measurement	-0.1	-	0.1	V

Electrical Characteristics Measurement Circuit



Application Circuit



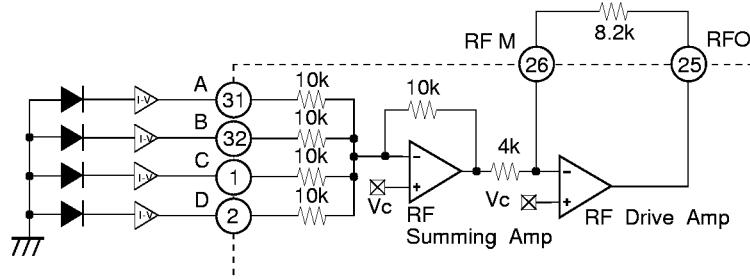
Application circuits shown are typical examples illustrating the operation of the devices. Sony cannot assume responsibility for any problems arising out of the use of these circuits or for any infringement of third party patent and other right due to same.

Description of Operation

RF Amplifier

The signal currents from the photodiodes A, B, C and D are I-V converted, and input to Pins 1, 2, 31 and 32.

These signals are added at the RF summing amplifier and inverted at the RF drive amplifier. Output is to Pin 25.

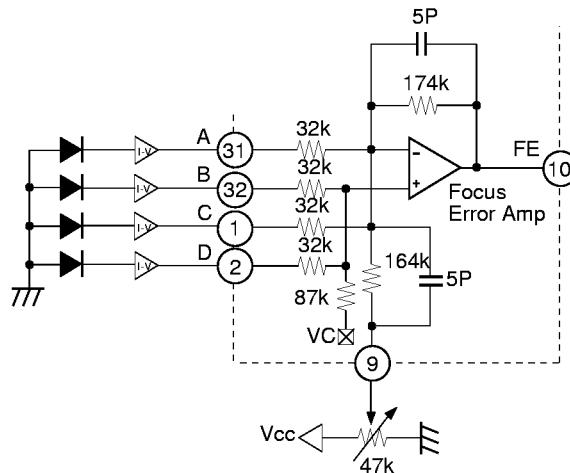


The low frequency component of RFO output voltage is as follows:

$$\begin{aligned} V_{RFO} &= \frac{10k}{10k} \times \frac{8.2k}{4k} \times (A + B + C + D) \\ &= 2.05 \times (A + B + C + D) \end{aligned}$$

Focus Error Amplifier

The operation of $(B + D) - (A + C)$ is performed and the resulting signal is output to Pin 10.



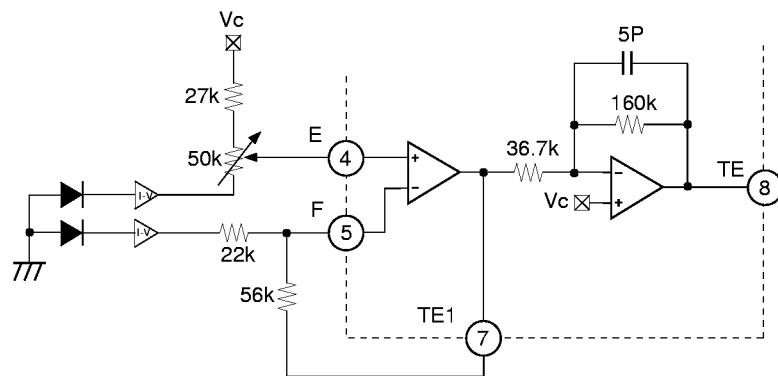
The low frequency component of FE output voltage is as follows:

$$\begin{aligned} V_{FE} &= \frac{174k}{32k} \times (B + D - A - C) \\ &= 5.43 \times (B + D - A - C) \end{aligned}$$

Tracking Error Amplifier

The signal current from the photodiode F is I-V converted and input to Pin 5 via an input resistor. The signal current from the photodiode E is I-V converted, and input to Pin 4 after its gain is adjusted by the volume. These signals undergo operational amplification at the tracking error amplifier and tracking

drive amplifier, and are output to Pin 8. The input resistance and feedback resistance of the tracking error amplifier are configured with external resistors, so that the absolute errors and deviations of temperature characteristics for IC internal/external resistors are independent of the gain.

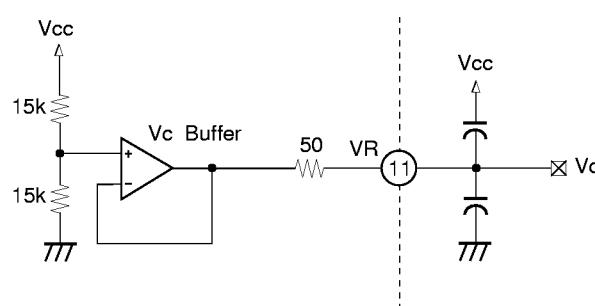


The low frequency component of TE output voltage is as follows:

$$\begin{aligned} V_{TE} &= \frac{56k}{22k} \times \frac{160k}{36.7k} \times (F - E) \\ &= 11.1 \times (F - E) \end{aligned}$$

Center Voltage Generation Circuit

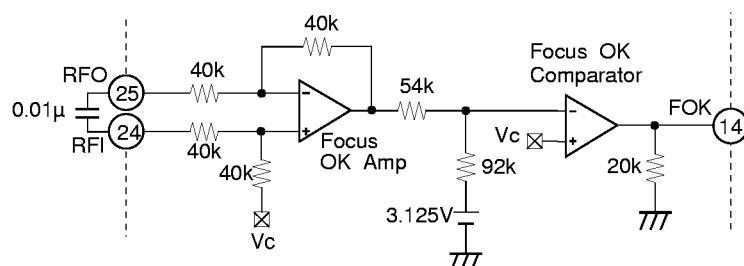
The center voltage of VR = (Vcc + GND) is supplied. The maximum current is approximately ± 3 mA.



Focus OK Circuit

The focus OK circuit creates the timing window okaying the focus servo form the focus search state. The low frequency component of RF can be get by obtaining the difference of the Pins 24 and 25 RF signals, whose low frequency components are removed, at the focus OK amplifier. The focus OK output is inverted when $V_{RFI} - V_{RFO} = -0.37V$. The capacitance

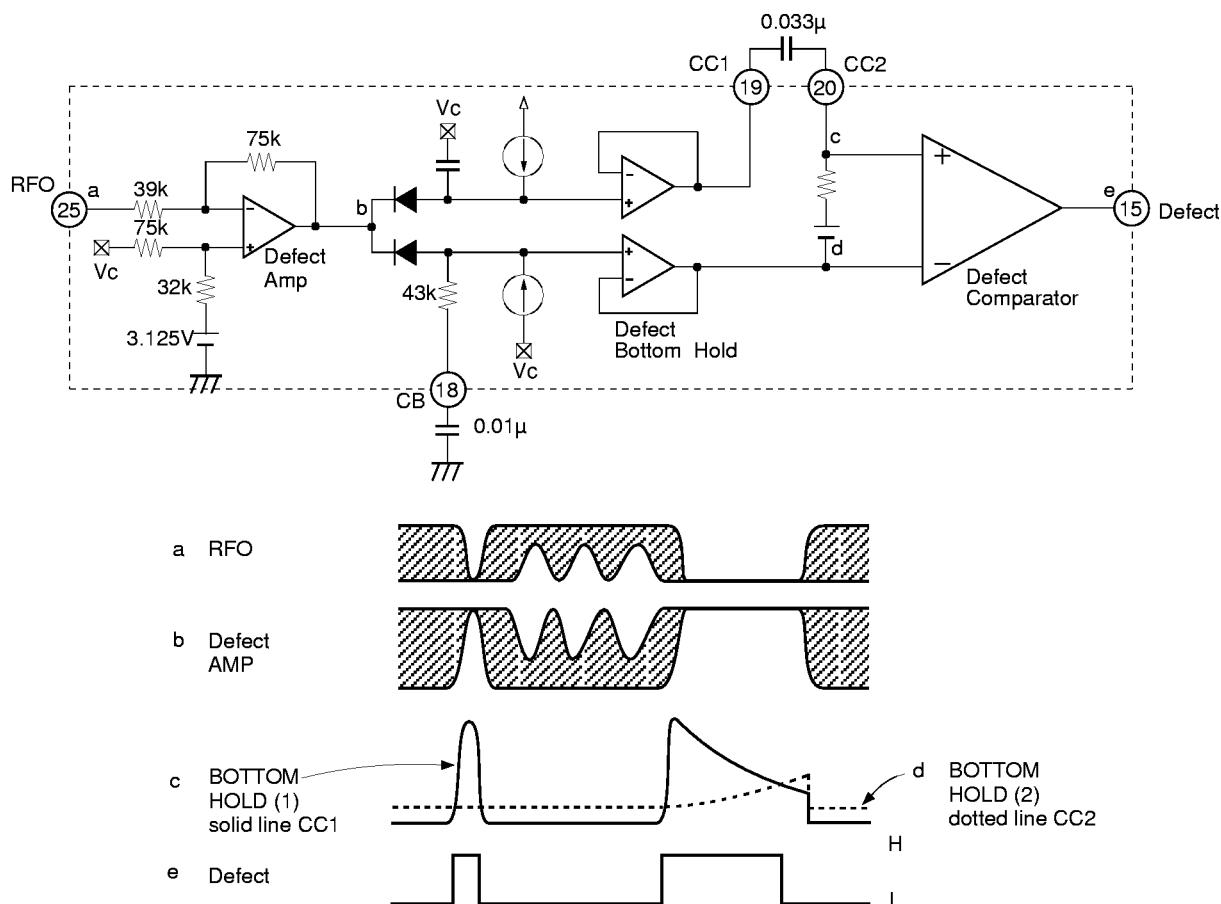
between Pins 24 and 25 is used to determine the time constants of the mirror circuit HPF and the focus OK amplifier LPF. In normal use, with C equal to $0.01\mu F$ selected, f_c is equal to $1kHz$, and block error rate degradation can be prevented which is caused by RF envelope defects due to scratched discs.



Defect Circuit

A bottom hold is performed on two time constants, long and short, after inversion of RFI signal. The mirror level is hold immediately prior to defect by short time

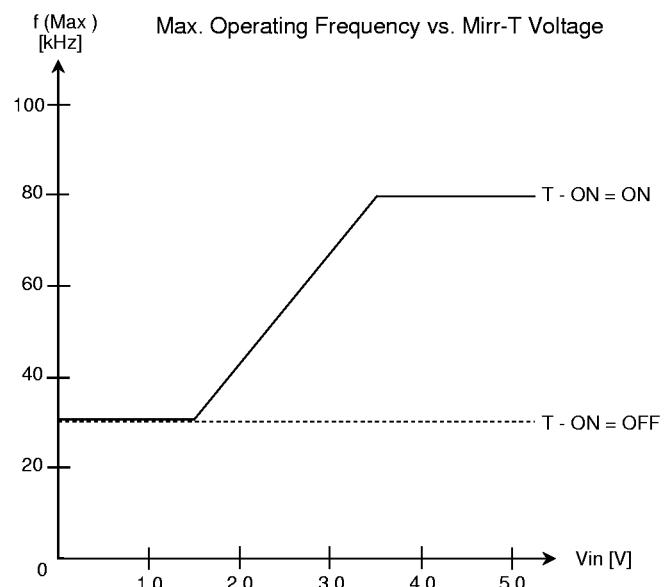
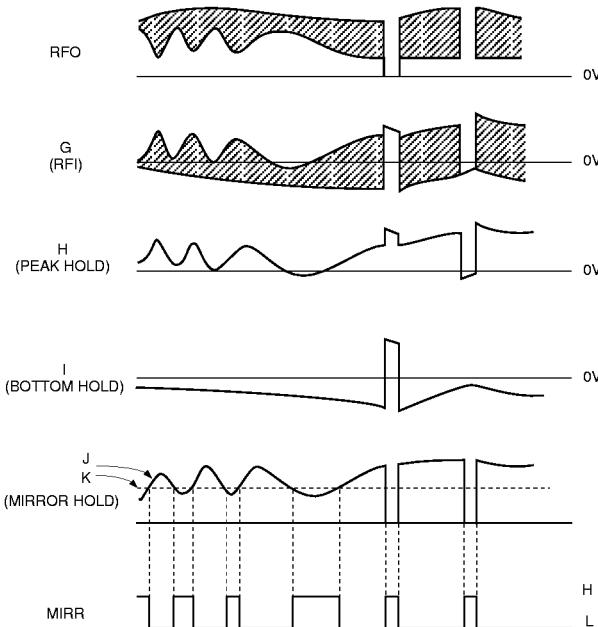
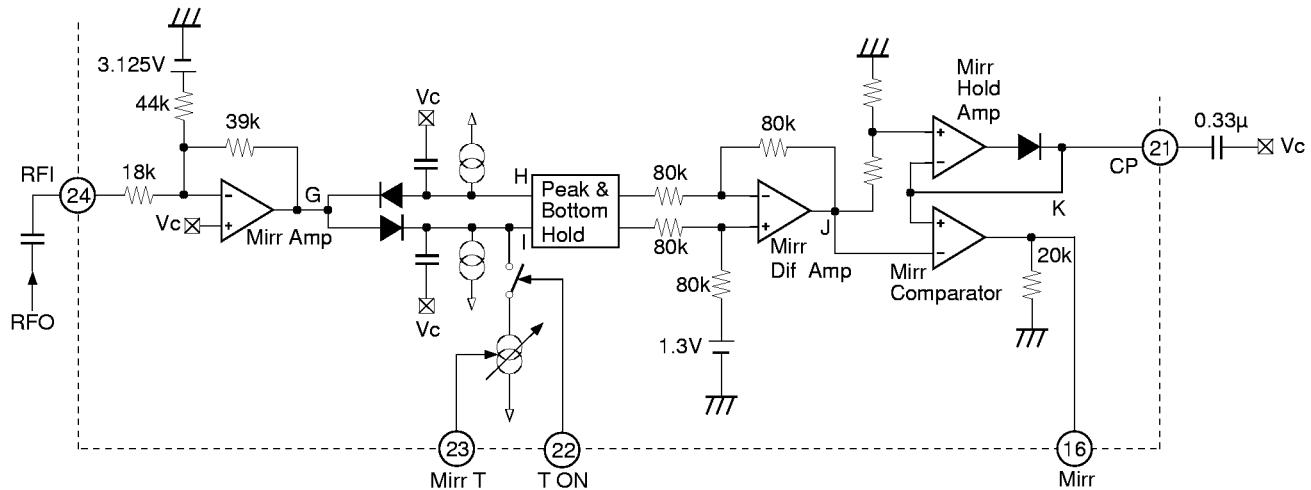
constant bottom hold. The mirror defect detection signal is output by performing a differential + level shift with capacitor coupling and then comparing both signals.



Mirror Circuit

Mirror circuit performs peak and bottom hold after RFT signal has been amplified. The peak hold is executed for Pin 22 with the time constant which follows the traverse signal of 30kHz for OFF (connection to

GND) and maximum 80kHz (adjustable with DC voltage of Pin 23) for ON (connection to Vcc). The bottom hold is executed with the time constant which follows the rotation cycle envelope fluctuation.



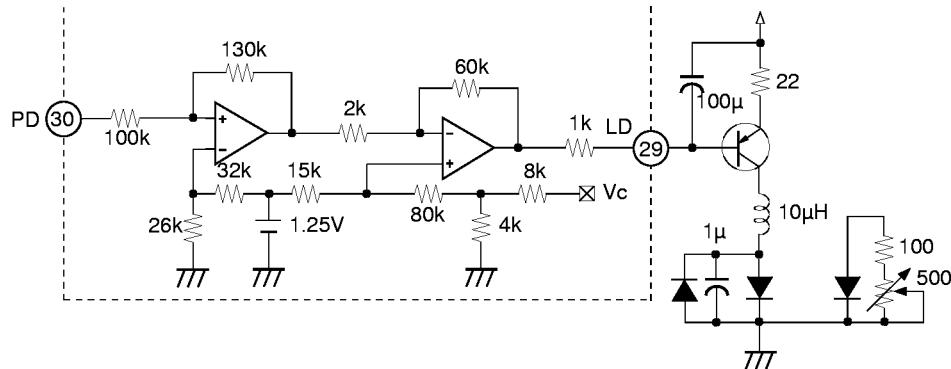
The mirror signal is output by comparing to the signal K (2/3 level of the J peak value which is peak-held with a large time constant) where the difference of hold signals H and I is obtained. The mirror output is low for tracks on the disc and high for the area between tracks

(the mirror areas). In addition, a high signal is output when a defect is detected. The mirror hold time constant must be sufficiently large in comparison with the traverse signal.

APC Circuit

When the laser diode is driven with constant current, the optical output possesses large negative temperature characteristics. Therefore, the current must be

controlled with the monitor photodiode to ensure the output remains constant. When LD ON pin is connected to GND, APC is ON; connected to V_{cc}, it is OFF.



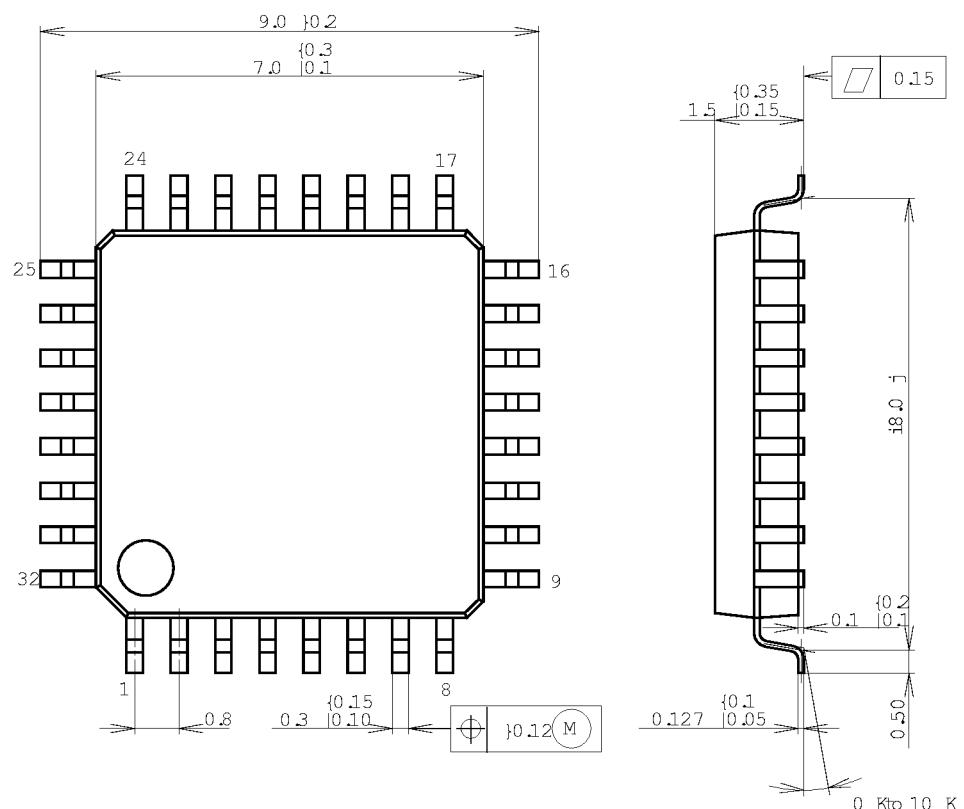
Notes on Handling

Care must be taken in handling because Pin 26 has low electrostatic strength of negative direction.

Package Outline

Unit : mm

32PIN QFP (PLASTIC)



PACKAGE STRUCTURE

PACKAGE MATERIAL	EPOXY RESIN
LEAD TREATMENT	SOLDER PLATING
LEAD MATERIAL	42ALLOY
PACKAGE WEIGHT	0.2g

SONY CODE	QFP-32P-L01
EIAJ CODE	*QFP032-P-0707-A
JEDEC CODE	_____